

Field Effect Transistor

Silicon N Channel MOS Type (π -MOS IV)

High Speed, High Current Switching, DC-DC Converter

Chopper Regulator and Motor Drive Applications

Features

- 4V Gate Drive
- Low Drain-Source ON Resistance
 - $R_{DS(ON)} = 1.06\Omega$ (Typ.)
- High Forward Transfer Admittance
 - $|Y_{fs}| = 6S$ (Typ.)
- Low Leakage Current
 - $I_{DSS} = 100\mu A$ (Max.) @ $V_{DS} = 600V$
- Enhancement-Mode
 - $V_{th} = 2.0 \sim 4.0V$ @ $V_{DS} = 10V, I_D = 1mA$

Absolute Maximum Ratings ($T_a = 25^\circ C$)

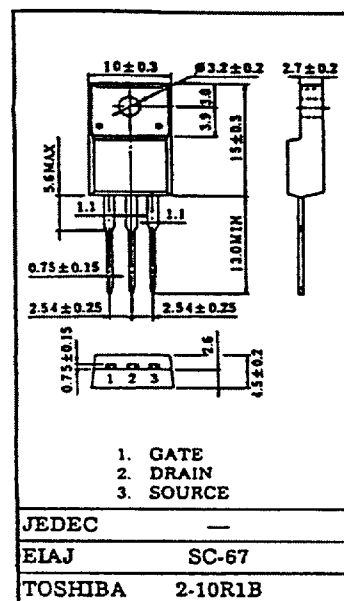
CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	600	V
Drain-Gate Voltage ($R_{GS} = 20k\Omega$)	V_{DGR}	600	V
Gate-Source Voltage	V_{GSS}	± 30	V
Drain Current	DC	I_D	A
	Pulse	I_{DP}	
Drain Power Dissipation ($T_c = 25^\circ C$)	P_D	45	W
Channel Temperature	T_{ch}	150	$^\circ C$
Storage Temperature Range	T_{stg}	-55 ~ 150	$^\circ C$

Thermal Characteristics

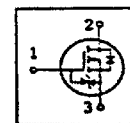
CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	1.25	$^\circ C/W$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	83.3	$^\circ C/W$

This transistor is an electrostatic sensitive device. Please handle with caution.

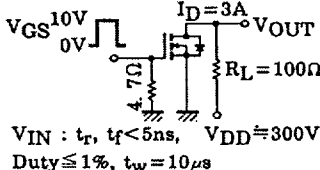
Unit in mm



Weight : 1.9g



Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	$V_{GS} = \pm 25V, V_{DS} = 0V$	—	—	± 10	μA
Gate-Source Breakdown Voltage		$V_{(BR)GSS}$	$I_G = \pm 100\mu A, V_{DS} = 0V$	± 30	—	—	V
Drain Cut-off Current		I_{DSS}	$V_{DS} = 600V, V_{GS} = 0V$	—	—	100	μA
Drain-Source Breakdown Voltage		$V_{(BR)DSS}$	$I_D = 10mA, V_{GS} = 0V$	600	—	—	V
Gate Threshold Voltage		V_{th}	$V_{DS} = 10V, I_D = 1mA$	2.0	—	4.0	V
Drain-Source ON Resistance		$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 3A$	—	1.06	1.25	Ω
Forward Transfer Admittance		$ Y_{fs} $	$V_{DS} = 10V, I_{DS} = 3A$	4.0	6.0	—	S
Input Capacitance		C_{iss}	$V_{DS} = 10V, V_{GS} = 0V,$ $f = 1MHz$	—	1250	—	pF
Reverse Transfer Capacitance		C_{rss}		—	75	—	
Output Capacitance		C_{oss}		—	320	—	
Switching Time	Rise Time	t_r	 <p>$V_{GS} = 10V, V_{DS} = 0V, I_D = 3A, R_L = 100\Omega$ $V_{IN} : t_r, t_f < 5ns, V_{DD} = 300V$ $Duty \leq 1\%, t_w = 10\mu s$</p>	—	14	—	ns
	Turn-on Time	t_{on}		—	35	—	
	Fall Time	t_f		—	12	—	
	Turn-off Time	t_{off}		—	65	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	$V_{DD} = 400V, V_{GS} = 10V,$ $I_D = 6A$	—	30	—	nC
Gate-Source Charge		Q_{gs}		—	18	—	
Gate-Drain ("Miller") Charge		Q_{gd}		—	12	—	

Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	—	—	—	6	A
Pulse Drain Reverse Current	I_{DRP}	—	—	—	24	A
Diode Forward Voltage	V_{DSF}	$I_{DR} = 6A, V_{GS} = 0V$	—	—	1.8	V
Reverse Recovery Time	t_{rr}	$I_{DR} = 6A, V_{GS} = 0V$	—	—	—	ns
Reverse Recovered Charge	Q_{rr}	$dI_{DR}/dt = 100A/\mu s$	—	—	—	μC

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